

### 1. Features

- Typical 1dB bandwidth of 20.1 MHz
- High attenuation
- Single Ended Operation
- Dual In-line Package (DIP)

**RoHS Compliant**

Tested by SGS Testing Korea

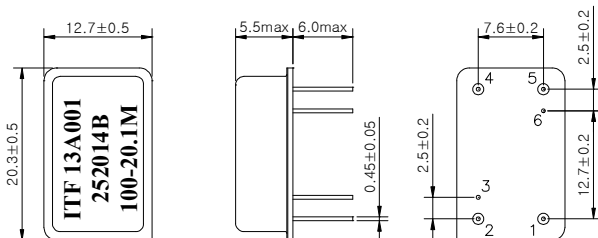
### 2. Electrical Specifications

Source and Load Impedance = 50Ω

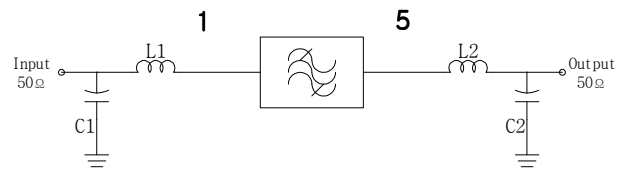
Operating Temperature : -20 °C ~ + 70 °C		Minimum	Typical	Maximum
Center Frequency (fo)	MHz	-	100.0	-
Insertion Loss	dB	-	22.0	23.5
1dB Bandwidth	MHz	19.9	20.1	-
3dB Bandwidth	MHz	-	20.43	-
40dB Bandwidth	MHz	-	21.82	22.0
Amplitude Ripple (fo ± 9.515 MHz)	dB	-	0.55	1.0
Group Delay Variation (fo ± 9.515 MHz)	nsec	-	40	80
Absolute Delay	usec	-	2.07	-
Ultimate Rejection	dB	50	55	-
Temperature Coefficient of Frequency	ppm/°C	-	-72	-

Room Temperature : + 25 °C		Minimum	Typical	Maximum
Insertion Loss	dB	-	22.0	23.5
Amplitude Ripple (fo ± 9.84 MHz)	dB	-	0.55	1.0
Group Delay Variation (fo ± 9.84 MHz)	nsec	-	40	80

#### D2012 Package Dimension



#### Matching Schematic



$$L1 = L2 = 82\text{nH}, C1 = 14\text{pF}, C2 = 22\text{pF}$$

Dimensions shown are nominal in millimeters

Base : Fe(SPCC), Au plating over Ni plated  
Cap : Cu & Cr Alloy, Ni Plated  
Termination : Kovar, Au Plated

#### Pin Configuration

Pin Configuration			
Input	1	Ground	2,4
Output	5	Others	Ground

**3. Typical Performance ( at +25°C )**

